NE5534, NE5534A LOW-NOISE OPERATIONAL AMPLIFIERS

SLOS070B - JULY 1979 - REVISED FEBRUARY 2004

- Equivalent Input Noise Voltage . . .
 3.5 nV/√Hz
- Unity-Gain Bandwidth . . . 10 MHz Typ
- Common-Mode Rejection Ratio . . .
 100 dB Typ
- High DC Voltage Gain . . . 100 V/mV Typ
- Peak-to-Peak Output Voltage Swing
 32 V Typ With V_{CC±} = ±18 V and R_L = 600 Ω
- High Slew Rate . . . 13 V/μs Typ
- Wide Supply-Voltage Range ±3 V to ±20 V
- Low Harmonic Distortion
- Offset Nulling Capability
- External Compensation Capability

description/ordering information

The NE5534 and NE5534A are high-performance operational amplifiers combining excellent dc and ac characteristics. Some of the features include very low noise, high output-drive capability, high unity-gain and maximum-output-swing bandwidths, low distortion, and high slew rate.

These operational amplifiers are compensated internally for a gain equal to or greater than three. Optimization of the frequency response for various applications can be obtained by use of an external compensation capacitor between COMP and COMP/BAL. The devices feature input-protection diodes, output short-circuit protection, and offset-voltage nulling capability with use of the BALANCE and COMP/BAL pins (see the application circuit diagram).

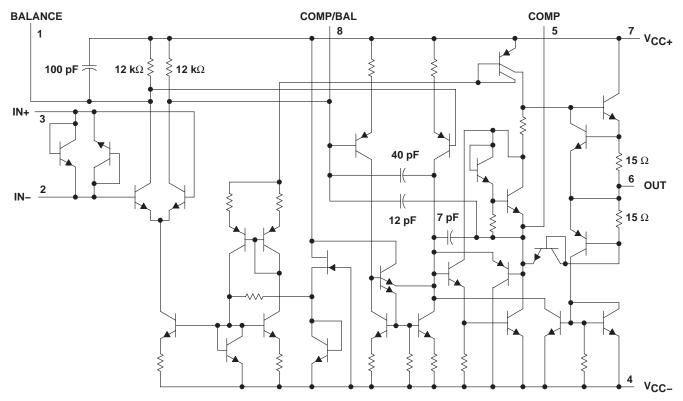
For the NE5534A, a maximum limit is specified for the equivalent input noise voltage.

ORDERING INFORMATION

TA	V _{IO} max AT 25°C	PACKAGET		PACKAGET		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	4 mV	PDIP (P)	Tube of 50	NE5534P	NE5534P		
			Tube of 50	NE5534AP	NE5534AP		
		SOIC (D)	Tube of 75	NE5534D	NEECOA		
			Reel of 2500	NE5534DR	NE5534		
			Tube of 75	NE5534AD	55044		
			Reel of 2500	NE5534ADR	5534A		
		SOP (PS)	Reel of 2000	NE5534PS	N5534		

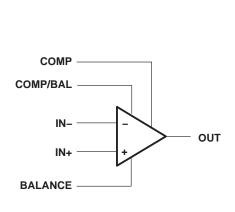
[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

schematic

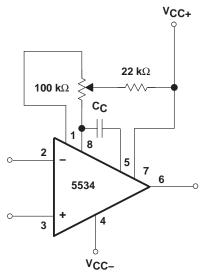


All component values shown are nominal.

symbol



application circuit



Frequency Compensation and Offset-Voltage Nulling Circuit

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage: V _{CC+} (see Note 1)		22 V
V _{CC} - (see Note 1)		
Input voltage either input (see Notes 1 and 2)		V _{CC+}
Input current (see Note 3)		±10 mA
Duration of output short circuit (see Note 4)		Unlimited
Package thermal impedance, θ _{JA} (see Notes 5 and 6)	: D package	97°C/W
	P package	85°C/W
	PS package	95°C/W
Operating virtual junction temperature, T _J		150°C
Storage temperature range, T _{stg}		65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-}.
 - 2. The magnitude of the input voltage must never exceed the magnitude of the supply voltage.
 - 3. Excessive current will flow if a differential input voltage in excess of approximately 0.6 V is applied between the inputs, unless some limiting resistance is used.
 - 4. The output may be shorted to ground or to either power supply. Temperature and/or supply voltages must be limited to ensure the maximum dissipation rating is not exceeded.
 - 5. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 6. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	MAX	UNIT
V _{CC+}	Supply voltage	5	15	V
VCC-	Supply voltage	-5	-15	V



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electrical characteristics, $V_{CC}\pm$ = ±15 V, T_A = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage	$V_O = 0$, $R_S = 50 \Omega$	T _A = 25°C		0.5	4	.,
			T _A = Full range			5	mV
		V _O = 0	T _A = 25°C		20	300	nA
lio	Input offset current		T _A = Full range			400	
	Level blee comment	V 0	T _A = 25°C		500	1500	~ ^
Iв	Input bias current	V _O = 0	T _A = Full range			2000	nA
VICR	Common-mode input voltage range			±12	±13		V
V		D. > 000 O	$V_{CC\pm} = \pm 15 \text{ V}$	24	26		V
VO(PP)	Maximum peak-to-peak output voltage swing	$R_L \ge 600 \Omega$	$V_{CC\pm} = \pm 18 \text{ V}$	30	32		
A	Large-signal differential voltage amplification	$V_{O} = \pm 10 \text{ V},$	T _A = 25°C	25	100		V/mV
AVD		$R_L \ge 600 \Omega$	T _A = Full range	15			
	Small-signal differential voltage amplification	f = 10 kHz	CC = 0		6		V/mV
A _{vd}			$C_C = 22 pF$		2.2		
	Maximum-output-swing bandwidth	V _O = ±10 V	CC = 0		200		- kHz
ВОМ			$C_C = 22 pF$		95		
DOIN		$V_{CC\pm} = \pm 18 \text{ V},$ $R_L \ge 600 \Omega,$	$V_O = \pm 14 \text{ V},$ $C_C = 22 \text{ pF}$		70		
B ₁	Unity-gain bandwidth	C _C = 22 pF,	C _L = 100 pF		10		MHz
rį	Input resistance			30	100		kΩ
z _O	Output impedance	$A_{VD} = 30 \text{ dB},$ $C_C = 22 \text{ pF},$	R _L ≥ 600 Ω, f = 10 kHz		0.3		Ω
CMRR	Common-mode rejection ratio	$V_O = 0$, $R_S = 50 \Omega$	VIC = VICRmin,	70	100		dB
ksvr	Supply-voltage rejection ratio (ΔV _{CC} /ΔV _{IO)}	$V_{CC+} = \pm 9 \text{ V to } \pm 15 \text{ V},$ $V_{O} = 0$	$R_S = 50 \Omega$,	80	100		dB
los	Output short-circuit current				38		mA
Icc	Supply current	V _O = 0, No load	T _A = 25°C		4	8	mA

[†] All characteristics are measured under open-loop conditions with zero common-mode input voltage, unless otherwise specified. Full range is $T_A = 0^{\circ}C$ to $70^{\circ}C$.

operating characteristics, $V_{\mbox{CC}}\,\pm$ = ± 15 V, $T_{\mbox{A}}$ = $25^{\circ}\mbox{C}$

PARAMETER		TEST SOMBITIONS	NE5534	NE5534A			
		TEST CONDITIONS	TYP	MIN TYP	MAX	UNIT	
CD	Slew rate	$C_C = 0$	13	13		\ \(\(\) \ \(\)	
SR		$C_C = 22 pF$	6	6		V/μs	
t _r	Rise time	$V_I = 50 \text{ mV}, \qquad A_{VD} = 1, \\ R_L = 600 \ \Omega, \qquad C_C = 22 \text{ pF}$	20	20		ns	
	Overshoot factor	$C_L = 100 \text{ pF}$	20	20		%	
	Rise time	$A_{L} = 50 \text{ mV}, \qquad A_{VD} = 1,$ $A_{L} = 600 \Omega, \qquad C_{C} = 47 \text{ pF}$ $A_{CL} = 500 \text{ pF}$	50	50		ns	
	Overshoot factor		35	35		%	
Vn	Equivalent input noise voltage	f = 30 Hz	7	5.5	7	nV/√ Hz	
		f = 1 kHz	4	3.5	4.5	nv/∀HZ	
	Equivalent input noise current	f = 30 Hz	2.5	1.5		pA/√ Hz	
In		f = 1 kHz	0.6	0.4		pa/\Hz	
F	Average noise figure	$R_S = 5 \text{ k}\Omega$, $f = 10 \text{ Hz to } 3$	20 kHz	0.9		dB	



TYPICAL CHARACTERISTICS[†]

NORMALIZED INPUT BIAS CURRENT AND INPUT OFFSET CURRENT

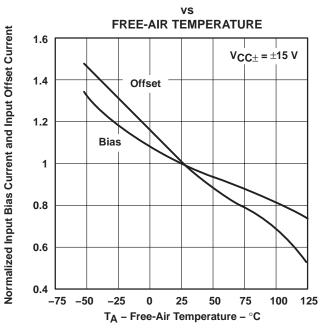


Figure 1

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE

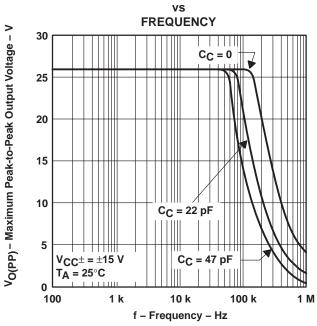
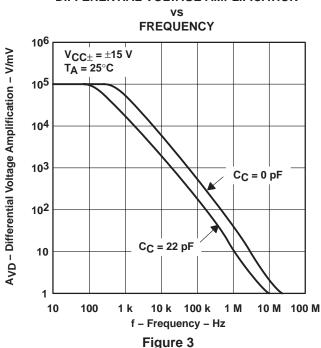
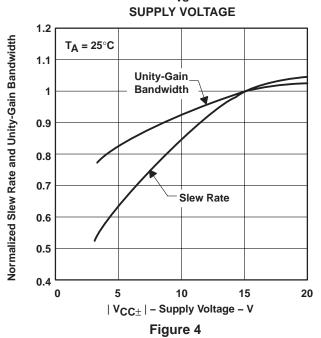


Figure 2

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION



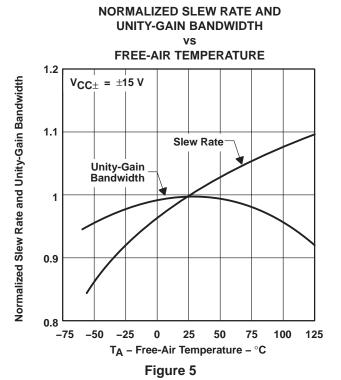
NORMALIZED SLEW RATE AND UNITY-GAIN BANDWIDTH

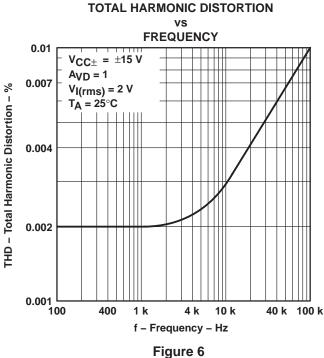


† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS[†]





EQUIVALENT INPUT NOISE VOLTAGE

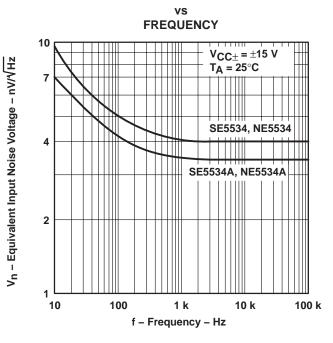


Figure 7

EQUIVALENT INPUT NOISE CURRENT

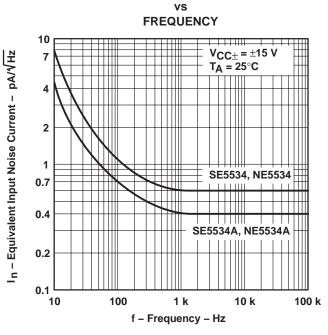


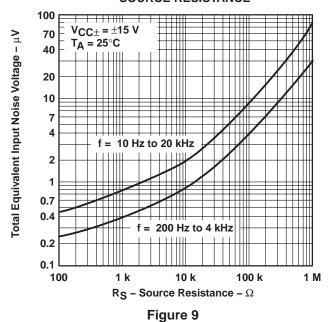
Figure 8

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



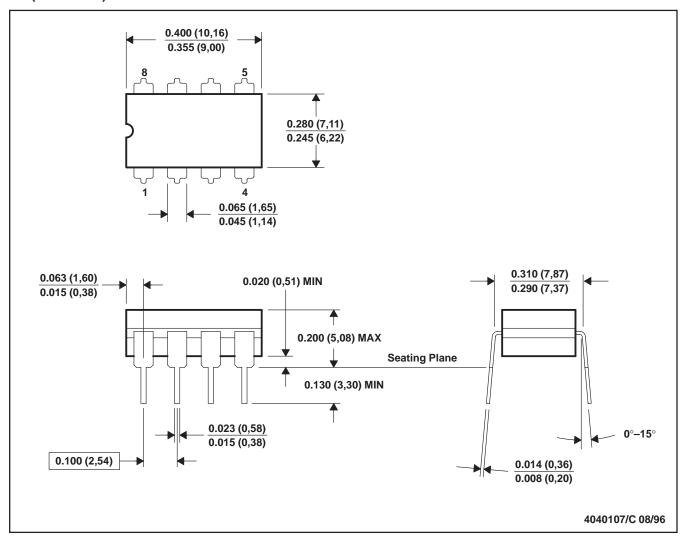
TYPICAL CHARACTERISTICS

TOTAL EQUIVALENT INPUT NOISE VOLTAGE vs SOURCE RESISTANCE



JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE

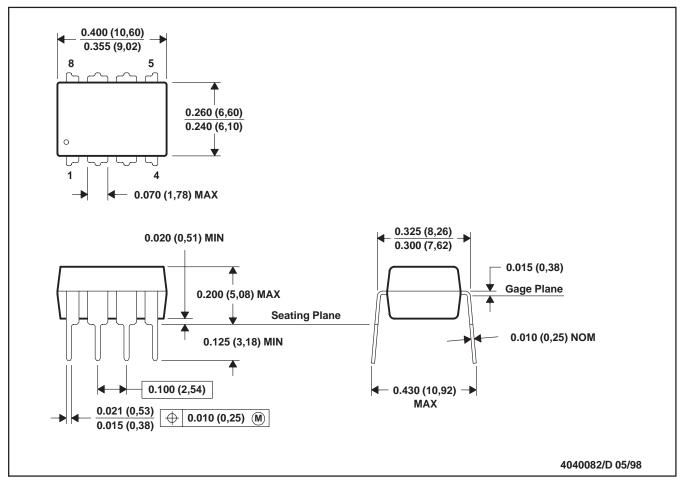


NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE

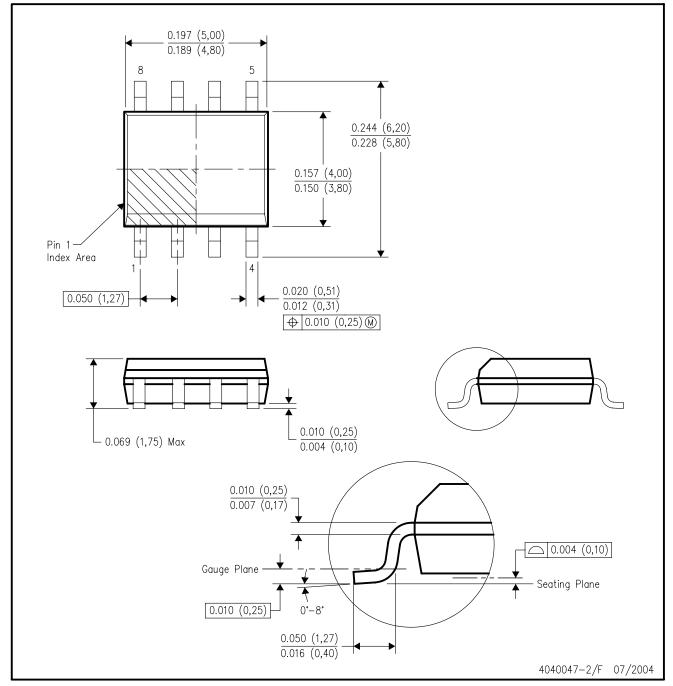


NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

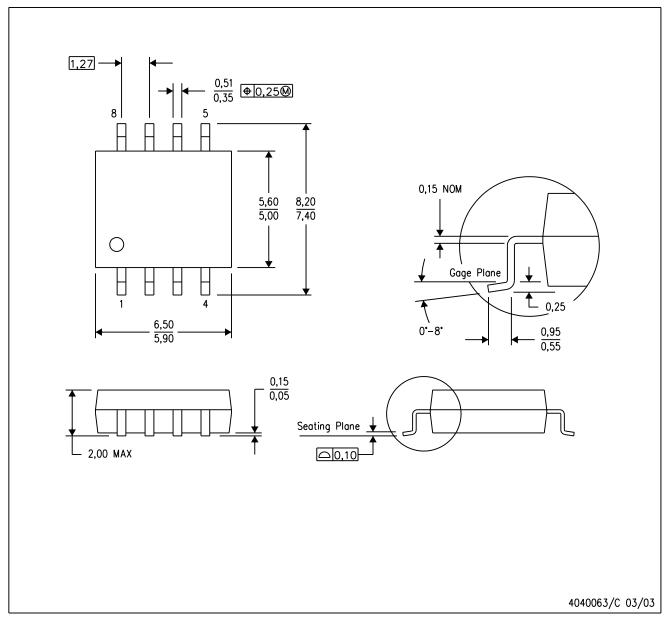
D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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